



PATENT

Customer No. 31561
Attorney Docket No.: 8810-US-PA

2814

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Applicant : Chi-Hsing Hsu
Application No. : 10/064,062
Filed : 2002/6/6
For : FLIP-CHIP DIE AND FLIP-CHIP PACKAGE SUBSTRATE
Examiner :

ASSISTANT COMMISSIONER FOR PATENTS
Washington, D.C. 20231

#2 Priority
Paper
10-21-02
R. H. Hsu

Dear Sirs:

Transmitted herewith is a certified copy of Taiwan Application No.: 2002/4/29,
filed on: 91205886.

A return prepaid postcard is also included herewith.

Respectfully Submitted,
JIANQ CHYUN Intellectual Property Office

Dated:

August 19, 2002

By:

Belinda Lee

Belinda Lee

Registration No.: 46,863

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11/15/02